	16 × 4 S		SN74LS FIRST-OUT MEM H 3-STATE OUTF 1991 – REVISED DECEMBE
•	Independent Synchronous Inputs and Outputs	N PACK (TOP VI	
•	16 Words by 4 Bits Each		
٠	3-State Outputs Drive Bus Lines Directly		16 UNCK
•	Data Rates up to 10 MHz	LDCK	14 OR
٠	Fall-Through Time 50 ns Typical	D0 []4	13 🛛 Q0
٠	Data Terminals Arranged for Printed Circuit Board Layout	D1 [5 D2 [6	12 Q1 11 Q2
•	Expandable Using External Gating		10 Q3
•	Packaged in Standard Plastic 300-mil DIPs	GND 8	9 CLR

description

The SN74LS224A 64-bit, low-power Schottky memory is organized as 16 words by 4 bits each. It can be expanded in multiples of 15m + 1 words or 4n bits, or both (where n is the number of packages in the vertical array and m is the number of packages in the horizontal array); however, some external gating is required. For longer words, the input ready (IR) signals of the first-rank packages and output ready (OR) signals of the last-rank packages must be ANDed for proper synchronization.

A first-in, first-out (FIFO) memory is a storage device that allows data to be written to and read from its array at independent data rates. These FIFOs are designed to process data at rates up to 10 MHz in a bit-parallel format, word by word.

The load clock (LDCK) normally is held low, and data is written into memory on the high-to-low transition of LDCK. The unload clock (UNCK) normally is held high, and data is read out on the low-to-high transition of UNCK. The memory is full when the number of words clocked in exceeds by 16 the number of words clocked out. When the memory is full, LDCK signals have no effect on the data residing in memory. When the memory is empty, UNCK signals have no effect.

Status of the FIFO memory is monitored by the IR and OR flags that indicate not-full and not-empty conditions. IR is high only when the memory is not full and LDCK is low. OR is high only when the memory is not empty and UNCK is high.

A low level on the clear (\overline{CLR}) input resets the internal stack-control pointers and also sets IR high and OR low to indicate that old data remaining at the data outputs is invalid. Data outputs are noninverting with respect to the data inputs and are at high impedance when the output-enable (OE) input is low. OE does not affect the IR and OR outputs.

The SN74LS224A is characterized for operation from 0°C to 70°C.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



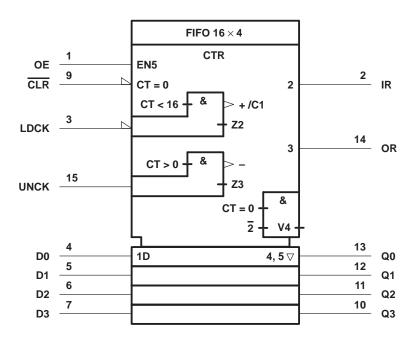
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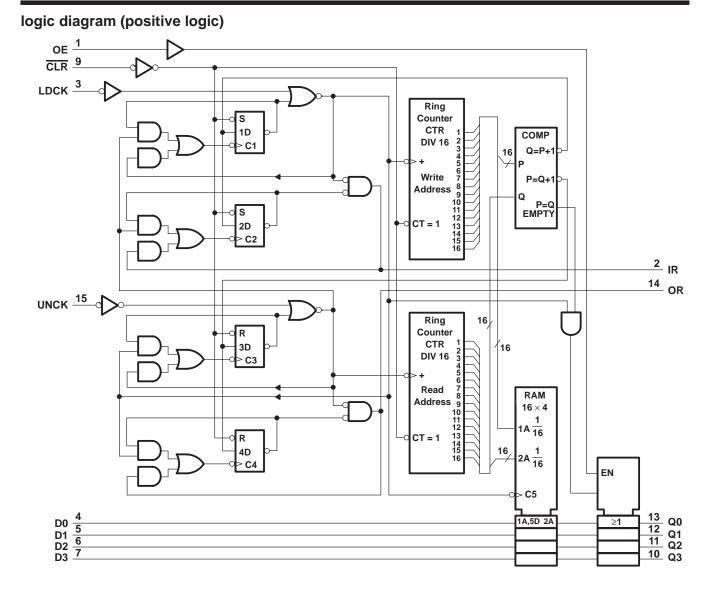
logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12. This symbol is functionally accurate but does not show the details of implementation; for these, see the logic diagram. The symbol represents the memory as if it were controlled by a single counter whose content is the number of words stored at the time. Output data is invalid when the counter content (CT) is 0.



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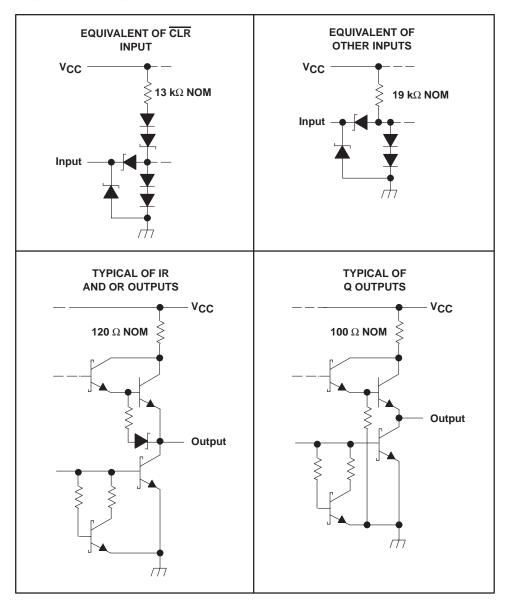




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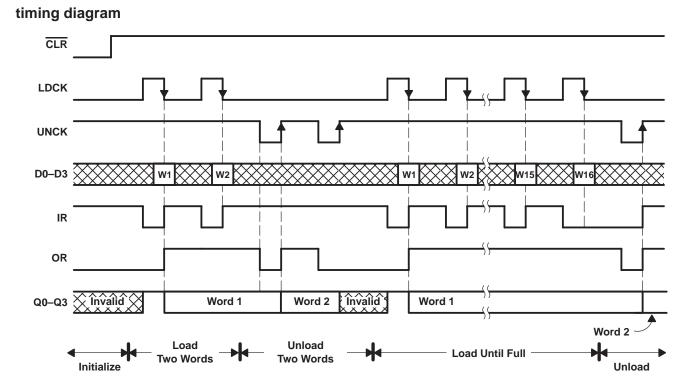
schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V _{CC} (see Note 1)	/ to 7 V
Input voltage range, V ₁ –0.5 \	/ to 7 V
Off-state output voltage range, V _O –0.5 V t	o 5.5 V
Package thermal impedance, θ_{JA} (see Note 2)	78°C/W
Storage temperature range, T _{stg}	150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to GND.

2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

		MIN	NOM	MAX	UNIT	
VCC	Supply voltage		4.75	5	5.25	V
VIH	High-level input voltage	l input voltage				V
VIL	Low-level input voltage	9			0.8	V
	High-level output current	Q outputs			-2.6	mA
IOH		IR, OR			-0.4	
lai	Low level output ourrent	Q outputs			24	mA
^I OL	Low-level output current	IR, OR			8	ША
T _A Operating free-air temperature		0		70	°C	

NOTE 3: To ensure proper operation of this high-speed FIFO device, it is necessary to provide a clean signal to the LDCK and UNCK clock inputs. Any excessive noise or glitching on the clock inputs that violates the V_{IL}, V_{IH}, or minimum pulse-duration limits can cause a false clock or improper operation of the internal read and write pointers.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	түр†	MAX	UNIT
VIK		V _{CC} = 4.75 V,	II = -18 mA			-1.5	V
VOH	Q outputs	V _{CC} = 4.75 V,	I _{OH} = -2.6 mA	2.4	3.4		V
	IR, OR	V _{CC} = 4.75 V,	I _{OH} = -0.4 mA	2.7	3.4		v
			I _{OL} = 12 mA		0.25	0.4	V μA
\/	Q outputs	V _{CC} = 4.75 V	I _{OL} = 24 mA		0.35	0.5	
VOL			I _{OL} = 4 mA		0.25	0.4	v
	IR, OR	V _{CC} = 4.75 V	I _{OL} = 8 mA		0.35	0.5	
IOZH	Q outputs	V _{CC} = 5.25 V,	V _O = 2.7 V			20	μΑ
IOZL	Q outputs	V _{CC} = 5.25 V,	$V_{O} = 0.4 V$			-20	μΑ
Ιį	-	V _{CC} = 5.25 V,	V ₁ = 7 V			0.1	mA
IIН		V _{CC} = 5.25 V,	V ₁ = 2.7 V			20	μΑ
IIL		V _{CC} = 5.25 V,	V ₁ = 0.4 V			-0.4	mA
los‡	Q outputs			-30		-130 -100	
	IR, OR	$V_{CC} = 5.25 V$		-20			mA
	-		Outputs high		84	135	
ICC		V _{CC} = 5.25 V	Outputs low		87	155 m 155	mA
			Outputs disabled		89		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

* Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

timing requirements over recommended operating conditions (see Note 3 and Figure 1)

			MIN	NOM	MAX	UNIT
tw		LDCK high	60			
		LDCK low	15			
	Pulse duration	UNCK low	30		1	ns
		UNCK high	30	30		
		CLR low	20			
		Data to LDCK↓	50			
t _{su}	Setup time	LDCK \downarrow before UNCK \downarrow	50			ns
		UNCK [↑] before LDCK [↑]	50			
th	Hold time	Data from LDCK \downarrow	10			ns

NOTE 3: To ensure proper operation of this high-speed FIFO device, it is necessary to provide a clean signal to the LDCK and UNCK clock inputs. Any excessive noise or glitching on the clock inputs that violates the VIL, VIH, or minimum pulse-duration limits can cause a false clock or improper operation of the internal read and write pointers.



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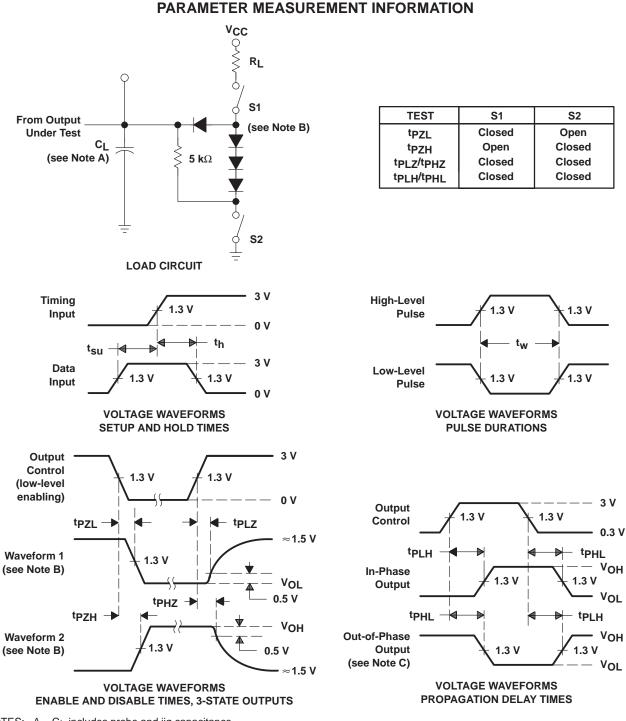
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

	FROM	ТО	TEST					
PARAMETER	(INPUT)	(OUTPUT)	CONDITIONS	TYP	MAX	UNIT		
^t PLH	IRE↑	IR	$R_L = 2 k\Omega$, $C_L = 15 pF$	N/A	N/A	ns		
^t PHL	IRE↓	IIX	$K_{L} = 2 K_{S2}, C_{L} = 10 \text{ pr}$	N/A	N/A	115		
^t PLH	ORE↑	OR	$R_{l} = 2 k\Omega$, $C_{l} = 15 pF$	N/A	N/A	ns		
^t PHL	ORE↓		$ _{1} = 2 _{2} $	N/A	N/A	115		
^t PLH	LDCK↓	IR RI	$R_L = 2 k\Omega$, $C_L = 15 pF$	25	40	ns		
^t PHL	LDCK↑	IX	= 2	36	50			
^t PLH	LDCK↓	OR	$R_L = 2 k\Omega$, $C_L = 15 pF$	48	70	ns		
^t PLH	UNCK↑	OR R	OR $R_L = 2 k\Omega$, $C_L = 15 pF$	$R_L = 2 k\Omega$, $C_L = 15 pF$	29	45	ns	
^t PHL	UNCK↓		= 2	28	45	115		
^t PLH	UNCK↑	IR	$R_L = 2 k\Omega$, $C_L = 15 pF$	49	70	ns		
^t PLH	CLR↓	IR	$R_L = 2 k\Omega$, $C_L = 15 pF$	36	55	ns		
^t PHL	CLR↓	OR	$\mathbf{N}_{\mathbf{L}} = \mathbf{Z} \mathbf{N}_{\mathbf{Z}}, \mathbf{O}_{\mathbf{L}} = 10 \mathbf{p}_{\mathbf{L}}$	25	40	115		
^t PHL	LDCK↓	Q	$R_L = 667 \ \Omega$, $C_L = 45 \ pF$	34	50	ns		
^t PLH	UNCKÎ	Q	$R_{I} = 667 \Omega$, $C_{I} = 45 pF$	54	80	ns		
^t PHL	UNCKT			NC = 007 32, OC = 40 pr	45	70	113	
tPZL		Q RL	$OE\uparrow$ Q $R_L = 667 \Omega$, $C_L =$	$R_1 = 667.0$ $C_1 = 45 \text{ pF}$	22	35	ns	
^t PZH	ULI					1. <u></u>	112 - 007 32, 0L - 40 pr	21
^t PLZ	OE↓		Q $R_1 = 667 \Omega, C_1 = 51$	R _L = 667 Ω, C _L = 5 pF	16	30	ns	
^t PHZ		8	NL = 007 32, 0L = 3 pr	18	30	ns		



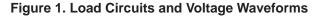
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NOTES: A. CI includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r < 15 ns, t_f < 6 ns, Z_O \approx 50 Ω .
- D. All diodes are 1N916 or 1N3064.
- E. The outputs are measured one at a time with one transition per measurement.





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